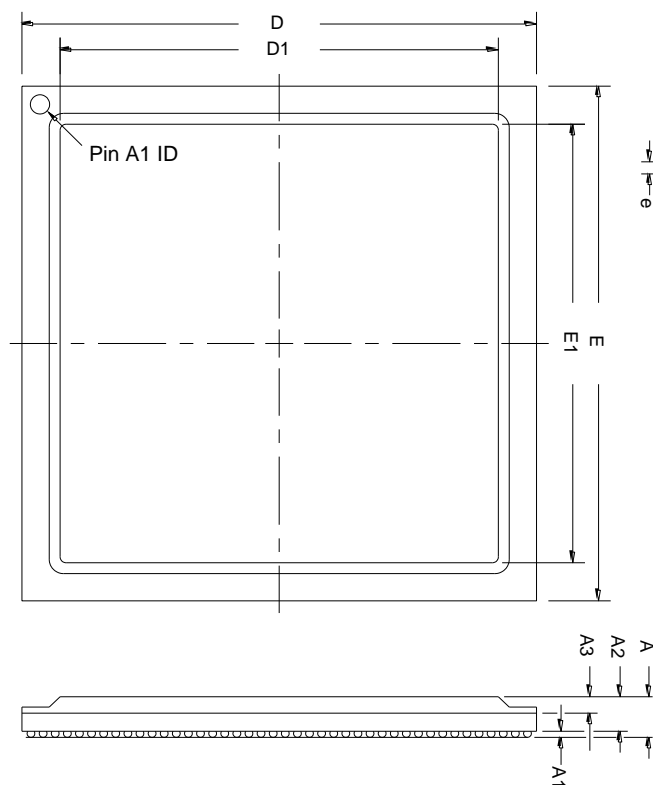
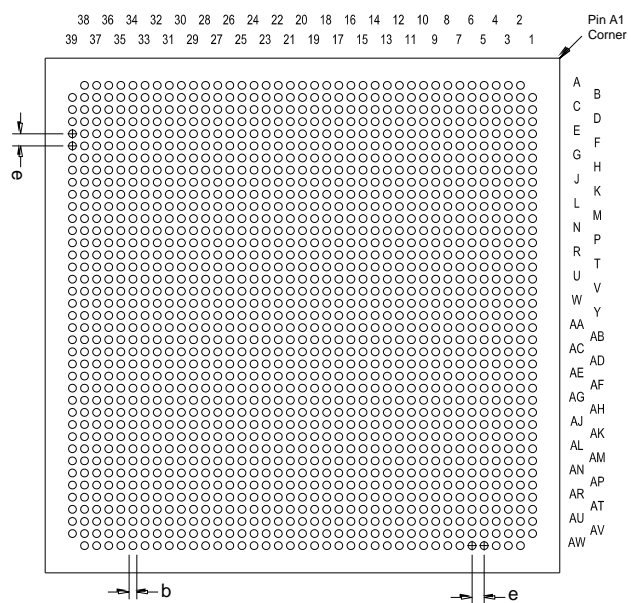


## 1517-Pin Hybrid FineLine Ball-Grid Array (HBGA) - Flip Chip - Single-Piece Lid - A:3.60 - D1:36.2

- All dimensions and tolerances conform to ASME Y14.5M – 1994.
- Controlling dimension is in millimeters.
- Pin A1 may be indicated by an ID dot, or a special feature, in its proximity on package surface.

Package Information	
Description	Specification
Ordering Code Reference	H
Package Acronym	HBGA
Substrate Material	BT
Solder ball composition	Regular: 63Sn:37Pb (Typ.) Pb-free: Sn:3Ag:0.5Cu (Typ.)
JEDEC Outline Reference	MS-034 Variation: AAV-1
Lead Coplanarity	0.010 inch (0.25 mm)
Weight	17.8 g (Typ.)
Moisture Sensitivity Level	Printed on moisture barrier bag

Package Outline Dimension Table			
Symbol	Millimeters		
	Min.	Nom.	Max.
A	3.20	3.40	3.60
A1	0.40	0.50	0.60
A2	2.60	2.90	3.20
A3	1.30	1.40	1.50
D	42.50 BSC		
D1	36.20 BSC		
E	42.50 BSC		
E1	36.20 BSC		
b	0.50	0.60	0.70
e	1.00 BSC		

**Package Outline****TOP VIEW****BOTTOM VIEW**

## Document Revision History

Table 1 shows the revision history for this document.

Table 1. Document Revision History

Date	Version	Changes
June 2011	1.0	Initial release



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